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(54) **SELECTABLY ATTACHABLE BUFFING PAD**

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A47L 11/16; A47L 11/162; B24D 13/14;
B24D 13/20; B24B 29/00
See application file for complete search history.

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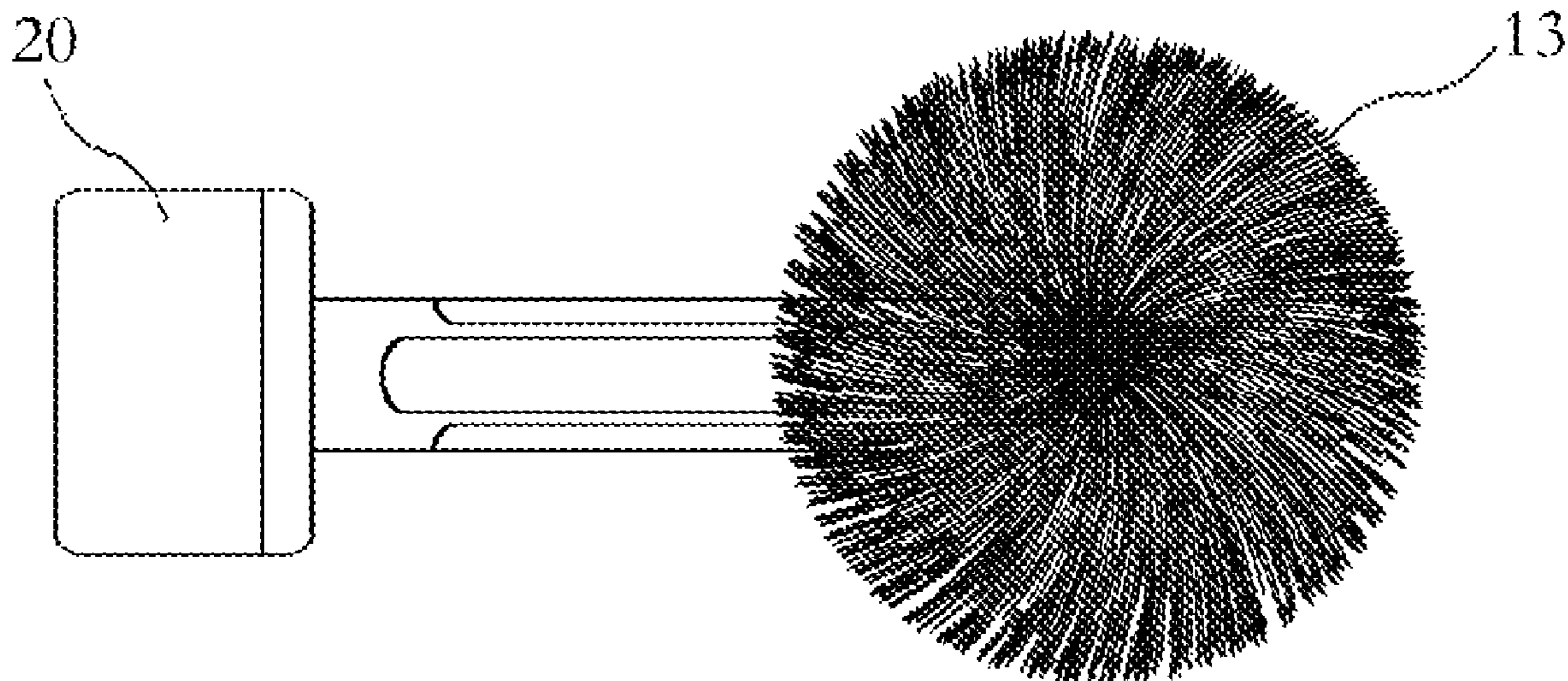
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(57) **ABSTRACT**

A selectively attachable buffer pad for using as an attachment to a conventional drill to buff or polish surfaces includes an attachment member which defines an elongated, rigid shank which is sized and shaped to be secured in the chuck of a conventional drill, a padded layer defining a planar body with a circular shape which is constructed out of a deformable material, and a buffer layer defining a conventional soft fiber buffing pad. Advantageously, the deformable nature of the padded layer enables selectively attachable buffer pad to transfer rotation from the attachment member to the buffer layer while also providing shock absorption. Thus, a conventional drill which is not otherwise suit for buffing or polishing is configured to accomplish the same through its attachment to the selectively attachable buffer pad.

4 Claims, 1 Drawing Sheet



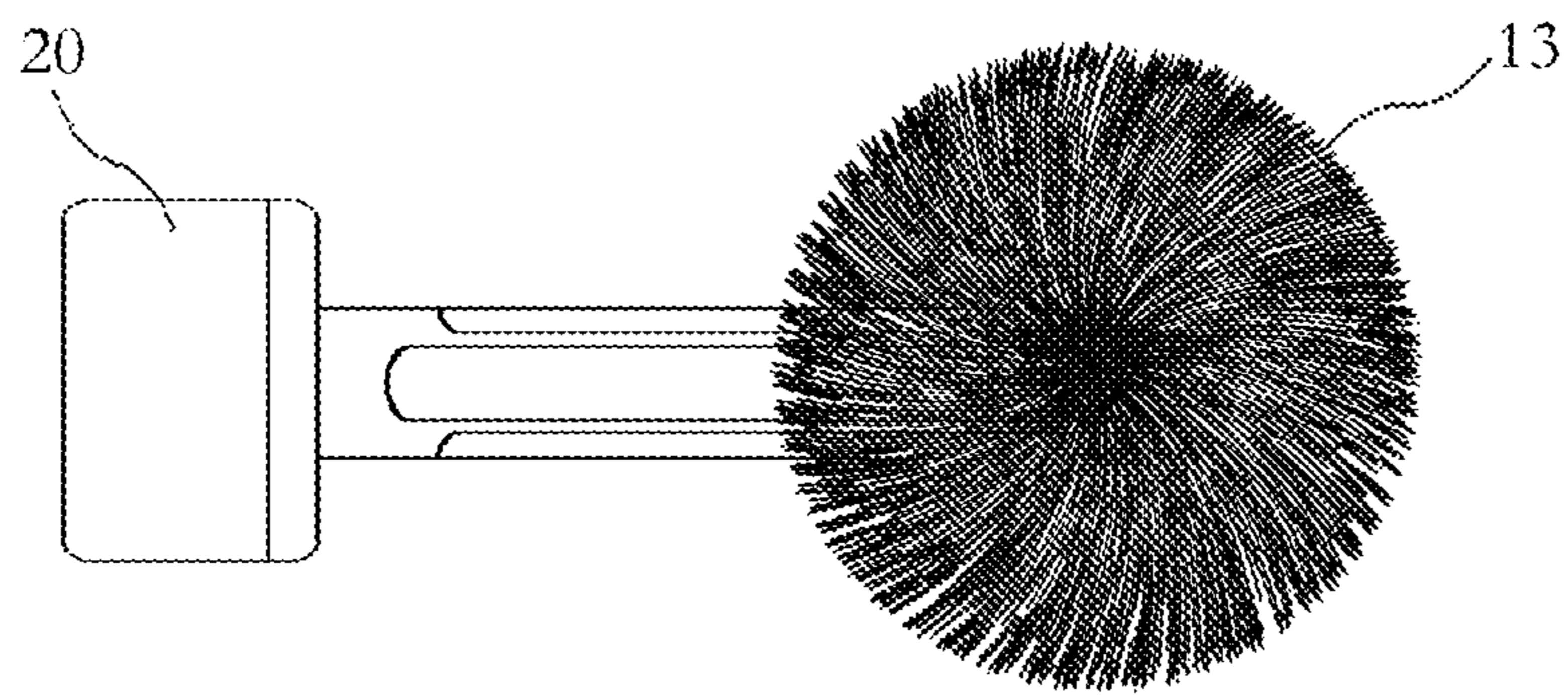


Fig. 1

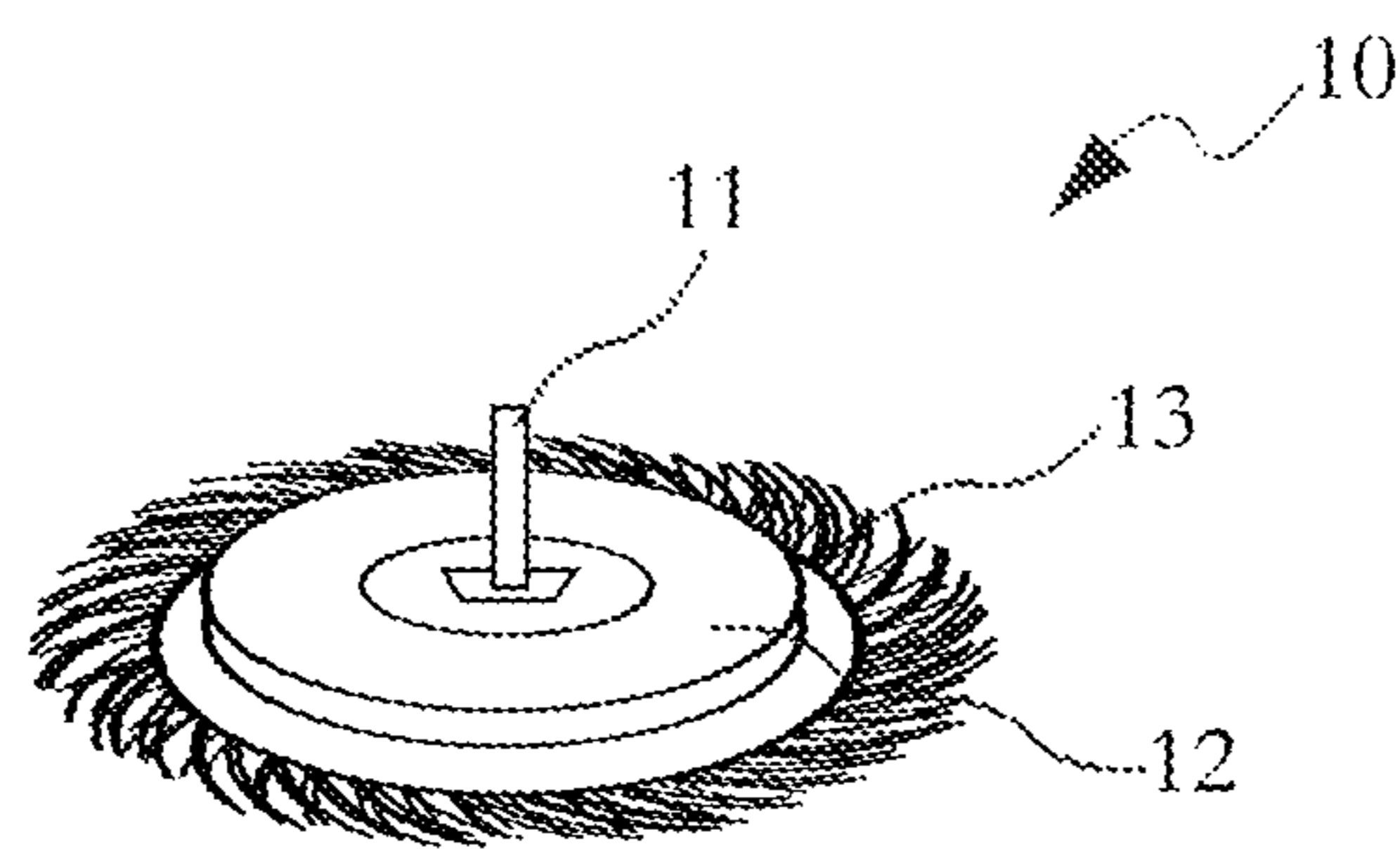


Fig. 2

SELECTABLY ATTACHABLE BUFFING PAD

BACKGROUND OF THE INVENTION

Field of the Invention

This invention relates generally to tool accessories and, more particularly, to a buffing pad that is selectively attachable to a sanding pad on a conventional sanding device.

Description of the Prior Art

The use and design of conventional electrical buffers/polishers is well known. Such conventional buffers/polishers typically define dedicated electrical devices have one or a plurality of buffer/polishing attachments which can be used. There remains a need, however, for a selectively attachable buffer pad which could be used with a conventional cordless drill, eliminating the need for a dedicated buffer. It would be helpful if such a selectively attachable buffer pad utilized a plural layer body which enabled the transfer of rotation to the buffing material while also cushioning the rigidity of the drill connection. It would be additionally desirable for the layers of such a selectively attachable buffer pad to be permanently fixed together so as to ensure the buffing material and cushion material remained in position to prevent inadvertent scratching of a surface.

The Applicant's invention described herein provides for a selectively attachable buffer pad adapted to allow a user to employ a conventional electrical drill, including a cordless drill, to buffer or polish a surface. The primary components in Applicant's selectively attachable buffer pad are an attachment member, a padded layer, and a buffer layer. When in operation, the selectively attachable buffer pad enables safe, effective buffing of surfaces in the absence of a dedicated buffer/polisher. As a result, many of the limitations imposed by prior art structures are removed.

SUMMARY OF THE INVENTION

A selectively attachable buffer pad for using as an attachment to a conventional drill to buff or polish surfaces. The selectively attachable buffer pad includes an attachment member which defines an elongated, rigid shank which is sized and shaped to be secured in the chuck of a conventional drill, a padded layer defining a planar body with a circular shape which is constructed out of a deformable material, and a buffer layer defining a conventional soft fiber buffing pad. Advantageously, the deformable nature of the padded layer enables selectively attachable buffer pad to transfer rotation from the attachment member to the buffer layer while also providing shock absorption. Thus, a conventional drill which is not otherwise suit for buffing or polishing is configured to accomplish the same through its attachment to the selectively attachable buffer pad.

It is an object of this invention to provide a selectively attachable buffer pad which could be used with a conventional cordless drill, eliminating the need for a dedicated buffer.

It is another object of this invention to provide a selectively attachable buffer pad which utilizes a plural layer body which enabled the transfer of rotation to the buffing material while also cushioning the rigidity of the drill connection.

It is yet another object of this invention to provide a selectively attachable buffer pad having layers that are permanently fixed together so as to ensure the buffing material and cushion material remained in position to prevent inadvertent scratching of a surface.

These and other objects will be apparent to one of skill in the art.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a bottom plan view of a selectively attachable buffer pad built in accordance with the present invention attached to a handheld, cordless drill.

FIG. 2 is a side perspective view of a selectively attachable buffer pad built in accordance with the present invention.

DETAILED DESCRIPTION OF THE INVENTION

Referring now to the drawings and in particular FIGS. 1 and 2, a selectively attachable buffer pad **10** is shown having an attachment member **11**, a padded layer **12**, and a buffer layer **13**. The attachment member **11** defines an elongated, rigid shank which is sized and shaped to be secured in the chuck of a conventional drill **20** at a distal end and is permanently fixed to the padded layer **12** at a proximal end. In this regard, the attachment member **11** enables the selectively attachable buffer pad **10** to be rotatably fixed to a conventional drill.

The padded layer **12** is a planar body with a circular shape which is constructed out of a deformable material. In one embodiment, the padded layer **12** is constructed out of a soft foam, such as a foam having a 12 indentation load deflection (ILD). In other embodiments, the padded layer **12** is constructed out of a hard foam, such as a foam having a 70 ILD. It is contemplated that the use of a padded layer **12** having a lower ILD (being relatively soft foam) configures the selectively attachable buffer pad **10** for use on surfaces that are relatively uneven, while the use of a padded layer **12** having a higher ILD (being relatively soft foam) configures the selectively attachable buffer pad **10** to work faster on surfaces that are substantially smooth.

In any embodiment, it is contemplated that because the padded layer **12** is able to yield to weight and pressure, it enables selectively attachable buffer pad **10** to transfer rotation from the attachment member **11** to the buffer layer **13** while absorbing shock, whether from a user's handling of the drill **20** or the contours of a surface being contacted by the buffer layer **13**.

The buffer layer **13** defines a conventional buffing pad. In some embodiments, the buffer layer **13** defines a twisted wool buffing pad or a microfiber buffing pad and has a 6 inch diameter. In such embodiments, the side of the buffer layer **13** opposite the twisted wool/microfiber is permanently fixed to the padded layer **12**. Advantageously, because the buffer layer's **13** 6 inch diameter is smaller than many conventional electrical buffers/polishers, it is able to reach into areas that would not be accessible to such conventional machines.

It is appreciated that while the selectively attachable buffer pad **10** may be used with any conventional drill that includes a chuck for attaching shanks, when used with cordless drills, such as an 18 volt cordless angle drill, the selectively attachable buffer pad **10** provides added portability relative to many conventional electrical buffers/polishers which require an electrical outlet.

It is contemplated that the attachment device **11** may be molded into the padded layer **12**, and the buffer layer **13** may be adhered to the padded layer **12**.

The instant invention has been shown and described herein in what is considered to be the most practical and preferred embodiment. It is recognized, however, that departures

tures may be made therefrom within the scope of the invention and that obvious modifications will occur to a person skilled in the art.

What is claimed is:

1. A selectively attachable buffer pad, comprising: 5
an attachment member defining an elongated, rigid shank
having a first end and a second end, wherein the first
end is sized and shaped to be secured in the chuck of
a conventional drill;
a padded layer constructed out of a deformable material, 10
wherein said deformable material has a specific inden-
tation load deflection adapted to yield to weight and
pressure and having an attachment side and an under
side, wherein said second end is integrated with said
attachment side, wherein the specific indentation load 15
deflection is 12; and
a buffer layer defining a soft fiber buffing pad having a top
side, wherein said top side is integrated with said under
side, wherein the padded layer enables the buffer layer
to transfer rotation from the attachment member to the 20
buffer layer while absorbing shock.
2. The selectively attachable buffer pad of claim 1,
wherein said second end is molded into said attachment side.
3. The selectively attachable buffer pad of claim 1,
wherein said top side and said under side are permanently 25
secured together through an adhesive.
4. The selectively attachable buffer pad of claim 1,
wherein the padded layer defines a planar body with a
circular shape and said buffer layer is circular, thereby
ensuring weight is evenly distributed when the rotated. 30

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